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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/040,224	01/02/2002	Ebrahim Andideh	42390P11353	2917
8791	7590 06/05/2002			
BLAKELY SOKOLOFF TAYLOR & ZAFMAN 12400 WILSHIRE BOULEVARD, SEVENTH FLOOR LOS ANGELES, CA 90025			EXAMINER	
			LEE, HSIEN MING	
			ART UNIT	PAPER NUMBER
			2823	# 1
			DATE MAILED: 06/05/2002	

Please find below and/or attached an Office communication concerning this application or proceeding.

			TA - Constant			
	•	Application No.	Applicant(s)			
		10/040,224	ANDIDEH, EBRAHIM			
	Office Action Summary	Examiner	Art Unit			
		Hsien-Ming Lee	2823			
Period fo	The MAILING DATE of this communication app r Reply	pears on the cover sheet	with the correspondence address			
THE N - Exter after - If the - If NO - Failui - Any r	ORTENED STATUTORY PERIOD FOR REPL'MAILING DATE OF THIS COMMUNICATION. Issions of time may be available under the provisions of 37 CFR 1.1 SIX (6) MONTHS from the mailing date of this communication. period for reply specified above is less than thirty (30) days, a reply period for reply is specified above, the maximum statutory period to reply within the set or extended period for reply will, by statute eply received by the Office later than three months after the mailing digital patent term adjustment. See 37 CFR 1.704(b).	36(a). In no event, however, may within the statutory minimum of will apply and will expire SIX (6) Notes that application to become	y a reply be timely filed thirty (30) days will be considered timely. MONTHS from the mailing date of this communication. E ABANDONED (35 U.S.C. § 133).			
1)	Responsive to communication(s) filed on	·				
2a)[☐	This action is FINAL . 2b)⊠ Th	is action is non-final.				
3) Since this application is in condition for allowance except for formal matters, prosecution as to the merits is closed in accordance with the practice under Ex parte Quayle, 1935 C.D. 11, 453 O.G. 213.						
•	on of Claims					
•	Claim(s) <u>1-30</u> is/are pending in the application 4a) Of the above claim(s) is/are withdra					
		wit itom consideration.				
• —	☐ Claim(s) is/are allowed. ☐ Claim(s) 1, 2, 5, 15, 17, 24, and 26, 30 is/are rejected.					
	Claim(s) <u>1-3,5-15,17-24 and 26-30</u> is/are rejected.					
• —	Claim(s) <u>4,16 and 25</u> is/are objected to. Claim(s) are subject to restriction and/o	or election requirement				
,	on Papers	, oloolon roquiromonii				
9) 🗆 .	The specification is objected to by the Examine	er.				
10) ☐ The drawing(s) filed on is/are: a) ☐ accepted or b) ☐ objected to by the Examiner.						
	Applicant may not request that any objection to the	e drawing(s) be held in at	peyance. See 37 CFR 1.85(a).			
11) ☐ The proposed drawing correction filed on is: a) ☐ approved b) ☐ disapproved by the Examiner.						
If approved, corrected drawings are required in reply to this Office action.						
12)☐ The oath or declaration is objected to by the Examiner.						
Priority under 35 U.S.C. §§ 119 and 120						
13) Acknowledgment is made of a claim for foreign priority under 35 U.S.C. § 119(a)-(d) or (f).						
a)	☐ All b)☐ Some * c)☐ None of:					
	1. Certified copies of the priority documents have been received.					
	2. Certified copies of the priority documents have been received in Application No					
 3. Copies of the certified copies of the priority documents have been received in this National Stage application from the International Bureau (PCT Rule 17.2(a)). * See the attached detailed Office action for a list of the certified copies not received. 						
14) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. § 119(e) (to a provisional application).						
 a) ☐ The translation of the foreign language provisional application has been received. 15)☐ Acknowledgment is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121. 						
Attachmen	t(s)					
2) Notic	te of References Cited (PTO-892) te of Draftsperson's Patent Drawing Review (PTO-948) mation Disclosure Statement(s) (PTO-1449) Paper No(s)	5) Notice	iew Summary (PTO-413) Paper No(s) e of Informal Patent Application (PTO-152)			

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DETAILED ACTION

1. Claim 13 is objected to because of the following informalities: lines 3-4, "the first conductive layer" should be – the first patterned conductive layer---. Appropriate correction is required.

Claim Rejections - 35 USC § 102

2. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (b) the invention was patented or described in a printed publication in this or a foreign country or in public use or on sale in this country, more than one year prior to the date of application for patent in the United States.
- 3. Claims 1-2, 13-14, 21-23 are rejected under 35 U.S.C. 102(b) as being anticipated by Lamey et al. (US 5,045,870).

Referring to Figs. 1, 2B and related text, Lamely et. al. identically teach the claimed method of forming a semiconductor device comprising:

- forming a first patterned conductive layer 19 on a dielectric material 17/15/10 on a substrate 11;
- forming a first barrier layer 21 comprising silicon nitride (col. 4, lines 4-5) on the surface of the first patterned conductive layer 19:
- forming a second barrier layer 23 comprising silicon carbide (col. 4, lines 4-5) on the surface of the first barrier layer 21, wherein the first 21 and second 23 barrier are formed by PECVD (col. 6, lines 55-57);
- forming a dielectric layer 25 on the surface of the second barrier layer 23; and
- forming a via through a first portion of the dielectric layer 17/15/10.

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Claim Rejections - 35 USC § 102

4. The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

- (e) the invention was described in-
- (1) an application for patent, published under section 122(b), by another filed in the United States before the invention by the applicant for patent, except that an international application filed under the treaty defined in section 351(a) shall have the effect under this subsection of a national application published under section 122(b) only if the international application designating the United States was published under Article 21(2)(a) of such treaty in the English language; or
- (2) a patent granted on an application for patent by another filed in the United States before the invention by the applicant for patent, except that a patent shall not be deemed filed in the United States for the purposes of this subsection based on the filing of an international application filed under the treaty defined in section 351(a).
- 5. Claims 1-3, 5 are rejected under 35 U.S.C. 102(e) as being anticipated by Liu et al. (US 6,392,254).

Referring to Figs, 11-12 and related text, Liu et. al. identically teach the claimed method of forming a semiconductor device comprising:

- forming a first patterned conductive layer 110/130 on a dielectric material 115A/115B on a substrate 106;
- forming a first barrier layer 132 on the surface of the first patterned conductive layer 110/130;
- forming a second barrier layer 134/140 on the surface of the first barrier layer 132;
- forming a dielectric layer 136 on the surface of the second barrier layer 134/140; and
- forming a via (the lower portion of the opening) through a first portion of the dielectric layer 136 and a trench (the upper portion of the opening) through a second portion of the dielectric layer 136 (Fig. 12).

Claim Rejections - 35 USC § 103

- 6. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 7. Claims 1, 6-13, 15, 17-20, 22, 24, 26-30 are rejected under 35 U.S.C. 103(a) as being unpatentable over Hussein et al. (US 6,365,529) in view of Lamey ('870).

Referring Figs. 1a-1h and related text, Hussein et al. teach the claimed method of forming a semiconductor device comprising:

- forming a first patterned conductive layer 101 on a dielectric material on a substrate 100, wherein the substrate 101 may include a dielectric material on the top surface of the substrate 100 (col. 3, lines 50-56);
- forming a barrier layer 102 (silicon nitride) on the surface of the first patterned conductive layer 101;
- forming a dielectric layer 103 on the surface of the barrier layer 102; and
- forming a via 107 through a first portion of the dielectric layer 103 and a trench 106 through a second portion of the dielectric layer 103.

Hussein et al. do not teach a second barrier on the surface of the barrier 102. Lamey et al. in an analogous art teach forming a first patterned conductive layer 19; forming a first barrier layer 21 (silicon nitride) on the surface of the first patterned conductive layer 19; and forming a second barrier layer 23 (silicon carbide) on the surface of the first barrier layer 21. Therefore, one of the ordinary skill in the art would have been motivated to modify Hussein's barrier layer

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102 by forming an additional barrier layer (i.e. the second barrier, silicon carbide) on the surface of the barrier layer 102 (silicon nitride), as taught by Lamey et al., since by forming dual barrier layers (silicon nitride and silicon carbide) on the patterned conductive layer pinholes in one film will have very low probability of directly aligning to a pinhole in the second film, thus making a relatively impervious combined film structure (col. 6, lines 55-64, Lamey et al.).

Regarding claims 6, 7, 18, 27-28, the given teaching of Hussein and Lamey would form the via 107 through the second barrier (silicon carbide) followed by forming the via 107 through the first barrier layer 102 (silicon nitride) with a etch pass.

Regarding claims 8-10, 19-20 and 29-30, the thickness of the first and second barrier layer are prima facie obvious without showing that the claimed ranges achieve unexpected results relative to the prior art range. In re Woodruff, 16 USPQ2d 1935, 1937 (Fed. Cir. 1990). See also In re Huang, 40 USPQ2d 1685, 1688(Fed. Cir. 1996)(claimed ranges of a result effective variable, which do not overlap the prior art ranges, are unpatentable unless they produce a new and unexpected result which is different in kind and not merely in degree from the results of the prior art). See also In re Boesch, 205 USPQ 215 (CCPA) (discovery of optimum value of result effective variable in known process is ordinarily within skill of art) and In re Aller, 105 USPQ 233 (CCPA 1955) (selection of optimum ranges within prior art general conditions is obvious).

Regarding claims 11-12, Lamely et al. teach that the first 21 and second 23 barrier are formed by PECVD (col. 6, lines 55-57).

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Allowable Subject Matter

8. Claims 4,16, 25 are objected to as being dependent upon a rejected base claim, but would be allowable if rewritten in independent form including all of the limitations of the base claim and any intervening claims.

9. The following is a statement of reasons for the indication of allowable subject matter:

The prior art of record, Lamey et al to US 5,045,870 and Liu et al. to 6,392,254 teach the claimed method as stated above except that the via is filled with a sacrificial light absorbing material comprising at least one of a dyed spin-on polymer and a dyed spin-on glass with dry etch properties similar to the dielectric layer.

10. Any inquiry concerning this communication or earlier communications from the examiner should be directed to Hsien-Ming Lee whose telephone number is 703-305-7341. The examiner can normally be reached on M-F (9:00 \sim 5:00).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor, Wael Fahmy can be reached on 703-308-4918. The fax phone numbers for the organization where this application or proceeding is assigned are 703-305-0142 for regular communications and 703-305-0142 for After Final communications.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the receptionist whose telephone number is 703-308-0956.

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Hsien Ming Lee June 1, 2002

PRIMATE EXAMINER